

PHP29N08T

N-channel TrenchMOS standard level FET

Rev. 02 — 12 March 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

1.2 Features and benefits

- High noise immunity due to high gate threshold voltage
- Low conduction losses due to low on-state resistance

1.3 Applications

Industrial motor control

1.4 Quick reference data

Table 1.	Quick reference					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	-	75	V
I _D	drain current	T _{mb} = 25 °C; V _{GS} = 11 V; see <u>Figure 1</u> ; see <u>Figure 3</u>	-	-	27	A
P _{tot}	total power dissipation	$T_{mb} = 25 \text{ °C}; \text{ see } \frac{\text{Figure 2}}{\text{Figure 2}}$	-	-	88	W
Dynamic	c characteristics					
Q _{GD}	gate-drain charge	$V_{GS} = 10 \text{ V}; I_D = 29 \text{ A};$ $V_{DS} = 60 \text{ V}; T_j = 25 \text{ °C};$ see <u>Figure 11</u>	-	9	-	nC
Static ch	naracteristics					
R _{DSon}	drain-source on-state resistance	V_{GS} = 11 V; I_D = 14 A; T_j = 175 °C; see <u>Figure 9</u> ; see <u>Figure 10</u>	-	96	120	mΩ
		$V_{GS} = 11 \text{ V}; I_D = 14 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } Figure 9;$ see Figure 10	-	40	50	mΩ

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2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	
3	S	source		
mb	D	mounting base, connected to drain		mbb076 S

SOT78 (TO-220AB; SC-46)

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PHP29N08T	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

4. Limiting values

Table 4. Limiting values

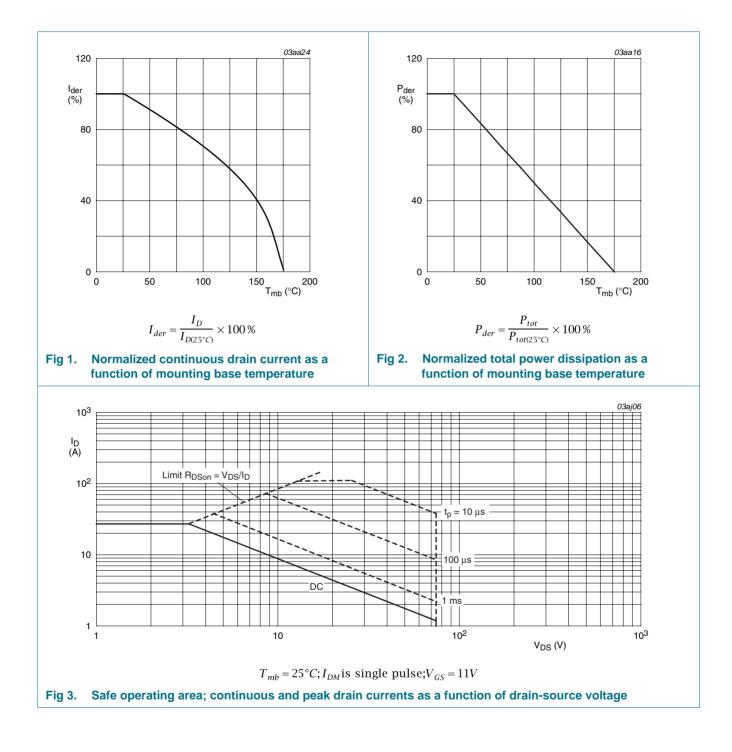
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	75	V
V _{DGR}	drain-gate voltage	T _j ≤ 175 °C; T _j ≥ 25 °C; R _{GS} = 20 kΩ	-	75	V
V _{GS}	gate-source voltage		-30	30	V
I _D	drain current	V_{GS} = 11 V; T_{mb} = 100 °C; see <u>Figure 1</u>	-	19.2	А
		V _{GS} = 11 V; T _{mb} = 25 °C; see <u>Figure 1</u> ; see <u>Figure 3</u>	-	27	A
I _{DM}	peak drain current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see <u>Figure 3</u>	-	108	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>	-	88	W
T _{stg}	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-dr	ain diode				
I _S	source current	T _{mb} = 25 °C	-	27	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$	-	108	А

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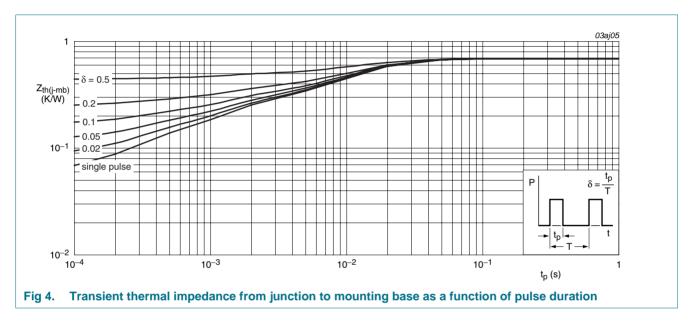
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5. Thermal characteristics

Table 5.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	see Figure 4	-	-	1.7	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	vertical in still air	-	60	-	K/W

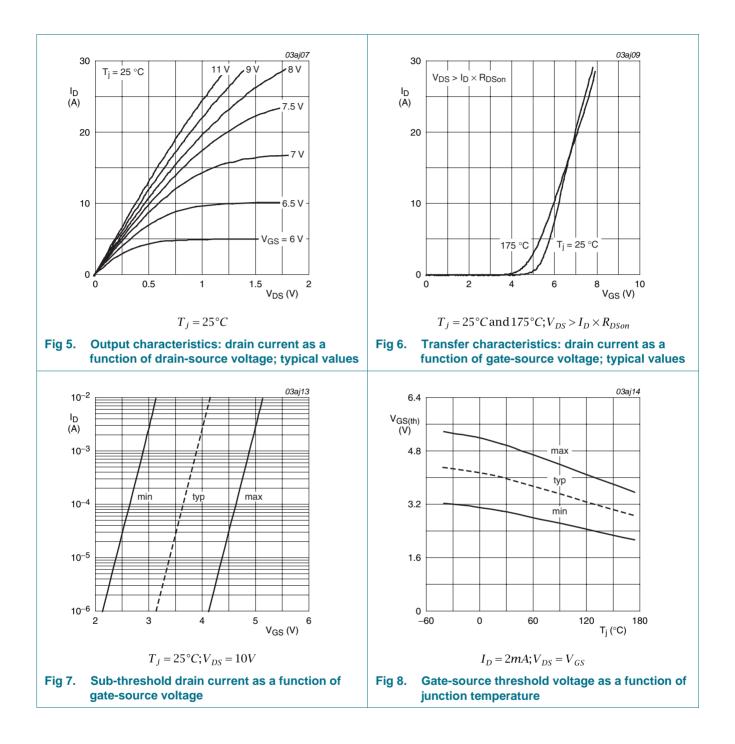


6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
V _{(BR)DSS}	drain-source	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ °C}$	70	-	-	V
	breakdown voltage	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	75	-	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 2 mA; V _{DS} = V _{GS} ; T _j = 175 °C; see <u>Figure 8</u>	2.1	-	-	V
		$I_D = 2 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see <u>Figure 8</u>	-	-	5.4	V
		$I_D = 2 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see Figure 8	3	4	5	V
I _{DSS}	drain leakage current	$V_{DS} = 75 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.05	10	μΑ
		$V_{DS} = 75 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 \text{ °C}$	-	-	500	μA
I _{GSS}	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C}$	-	10	100	nA
		V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C	-	10	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 11 V; I _D = 14 A; T _j = 175 °C; see <u>Figure 9</u> ; see <u>Figure 10</u>	-	96	120	mΩ
		V _{GS} = 11 V; I _D = 14 A; T _j = 25 °C; see <u>Figure 9</u> ; see <u>Figure 10</u>	-	40	50	mΩ
Dynamic	characteristics					
Q _{G(tot)}	total gate charge	$I_D = 29 \text{ A}; V_{DS} = 60 \text{ V}; V_{GS} = 10 \text{ V};$	-	19	-	nC
Q _{GS}	gate-source charge	$T_j = 25 \text{ °C}; \text{ see } Figure 11$	-	6	-	nC
Q _{GD}	gate-drain charge		-	9	-	nC
C _{iss}	input capacitance	$V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$	-	810	-	pF
C _{oss}	output capacitance	T _j = 25 °C; see <u>Figure 12</u>	-	140	-	pF
C _{rss}	reverse transfer capacitance		-	85	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 38 V; R_L = 1.3 Ω ; V_{GS} = 10 V;	-	9.5	-	ns
t _r	rise time	$R_{G(ext)} = 5.6 \ \Omega; T_j = 25 \ ^{\circ}C; I_D = 29 \ A$	-	70	-	ns
t _{d(off)}	turn-off delay time		-	15	-	ns
f	fall time		-	9	-	ns
Source-d	rain diode					
V _{SD}	source-drain voltage	I _S = 14 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 13</u>	-	0.95	1.2	V
rr	reverse recovery time	I_S = 14 A; dI_S/dt = -100 A/µs; V_{GS} = 0 V;	-	50	-	ns
Q _r	recovered charge	V _{DS} = 25 V; T _j = 25 °C	-	65	-	nC

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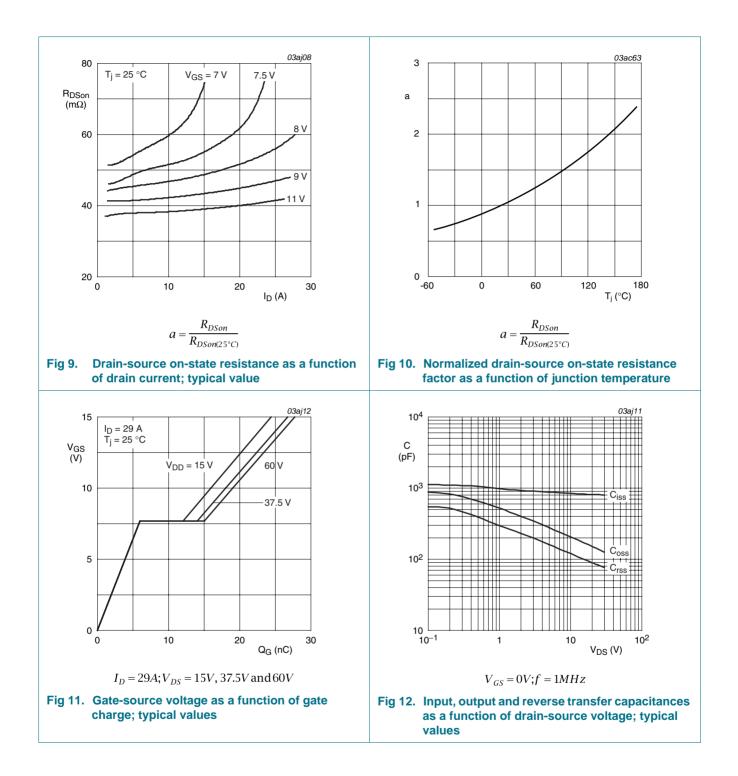
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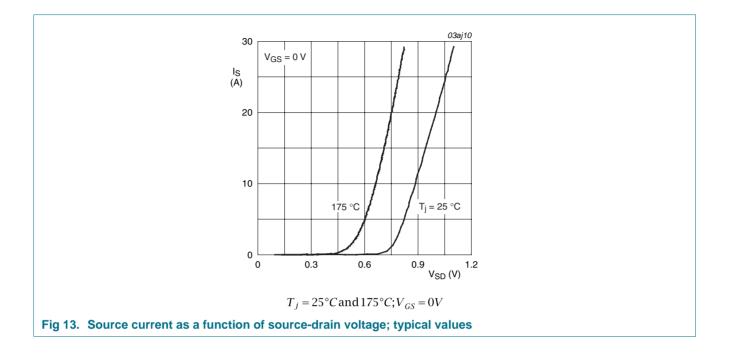
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7. Package outline

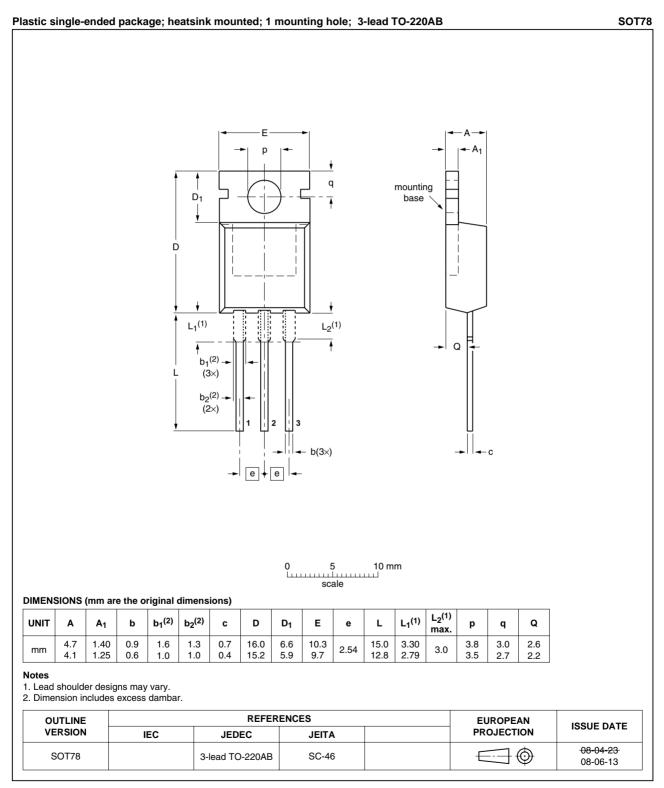


Fig 14. Package outline SOT78 (TO-220AB)

8. Revision history

Table 7. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PHP29N08T_2	20090312	Product data sheet	-	PHP_PHB29N08T-01
Modifications:		t of this data sheet has be of NXP Semiconductors.	•	y with the new identity
	 Legal texts 	s have been adapted to the	ne new company name v	vhere appropriate.
	 Type numl 	ber PHP29N08T_2 separ	ated from data sheet PH	P_PHB29N08T-01.
PHP_PHB29N08T-01 (9397 750 09651)	20020529	Product data	-	-

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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